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SEK 18 male low profile solder and press-in RoHS compliant				Recommended configuration of plated through holes for press-in termination In addition to the hot-air-level (HAL), other PCB surfaces are getting more important. Due to their different properties – such as mechanical strength and coefficient of friction – we recommend the following configuration of PCB through holes. <table><tr><td rowspan="3">Tin plated PCB (HAL) acc. to EN 60352-5</td><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td>Sn</td><td>max. 15 µm</td></tr><tr><td rowspan="3">Chemical tin plated PCB</td><td>plated hole Ø</td><td>0,94 – 1,09 mm</td></tr><tr><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td rowspan="4">Gold /Nickel plated PCB</td><td>Sn</td><td>min. 0,8µm</td></tr><tr><td>plated hole Ø</td><td>1,00 – 1,10 mm</td></tr><tr><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td rowspan="3">Silver plated PCB</td><td>Ni</td><td>3 – 7 µm</td></tr><tr><td>Au</td><td>0,05 – 0,12 µm</td></tr><tr><td>plated hole Ø</td><td>1,00 – 1,10 mm</td></tr><tr><td rowspan="3">Copper plated PCB (OSP)</td><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td>plated hole Ø</td><td>1,00 – 1,10 mm</td></tr></table> Assembly instructions It is highly recommended to use HARTING press-in tools to ensure a reliable press-in process. Please refer to the catalogue for tools, machines and further information about the press-in process. Soldering instructions The connectors should be protected when being soldered in a dip, flow or film soldering baths. Otherwise, they might become contaminated as a result of soldering operations or deformed as a result of overheating. (1) For prototypes and short runs protect the connectors with an industrial adhesive tape, e.g. Tesaband 4331 (www.tesa.de). Cover the underside of the connector moulding and the adjacent parts of the pcb as well as the open sides of the connector. This will prevent heat and gases of the soldering apparatus from damaging the connector. About 140 + 5 mm of the tape should suffice. (2) For large series a jig is recommended. Its protective cover with a fast action mechanical locking device shields the connectors from gas and heat generated by the soldering apparatus. As an additional protection a foil can be used for covering the parts that should not be soldered. Packaging material (only for plastic tray) <table><tr><td>Material</td><td>Polystyrol</td></tr><tr><td>Color</td><td>Yellow</td></tr><tr><td>Standardization</td><td>acc. to DIN EN / IEC 61340-5-1 and ANSI / ESD S541-2003</td></tr></table> - Safe protection for electronic components against electrostatic charges Cross section of solder terminations <table><tr><td rowspan="2"></td><td>All Dimensions in mm Original Size DIN A3</td><td>Scale 1:1</td><td>Free size tol.</td><td colspan="2">Ref.</td></tr><tr><td colspan="3"></td><td colspan="2">Sub. DS 09181100001 / 500000101780 / 2016-07-25</td></tr><tr><td rowspan="2"></td><td>All rights reserved</td><td>Created by STORCK</td><td>Inspected by LEHNERT</td><td>Standardisation HOFFMANN</td><td>Date 2016-09-05</td><td>State Final Release</td></tr><tr><td>Department EC PD - DE</td><td colspan="4">Title SEK 18 male low profile solder and press-in</td><td>Doc-Key / ECM-Nr. 100554984/UGD/001/F 500000107692</td></tr><tr><td colspan="2">HARTING Electronics GmbH D-32339 Espelkamp</td><td>Type DS</td><td colspan="2">Number 09181100001</td><td>Rev. F</td><td>Page 1/1</td></tr></table> General information <table><tr><td>Design</td><td colspan="3">IEC 60603-13</td></tr><tr><td>No. of contacts</td><td colspan="3">6,10,14,16,20,26,30,34,40,50,60,64</td></tr><tr><td>Contact spacing</td><td colspan="3">2,54 mm x 2,54 mm</td></tr><tr><td>Test voltage Ur.m.s</td><td colspan="3">1 kV</td></tr><tr><td>Working voltage</td><td colspan="3">500 V for pollution degree 1</td></tr><tr><td>Working current acc. to IEC 60512-2</td><td colspan="3">See derating diagram</td></tr><tr><td>Contact resistance</td><td colspan="3">max. 20mOhm</td></tr><tr><td>Insulation resistance</td><td colspan="3">min. 10^9Ohm</td></tr><tr><td>Temperature range</td><td colspan="3">-55°C ... +125°C (solder) -55°C ... +105°C (press-in)</td></tr><tr><td>Termination technology</td><td colspan="3">solder, press-in</td></tr><tr><td>Clearance & creepage distance</td><td colspan="3">min. 0,5 mm clearance min. 0,56 creepage</td></tr><tr><td rowspan="6">Insertion and withdrawal forces</td><td>6-pole max. 12N for PL1-2 / 18N for PL3</td><td colspan="2">; 30-pole max. 60N for PL1-2 / 90N for PL3</td></tr><tr><td>10-pole max. 20N for PL1-2 / 30N for PL3</td><td colspan="2">; 34-poles max. 68N for PL1-2 / 102N for PL3</td></tr><tr><td>14-pole max. 28N for PL1-2 / 42 for PL3</td><td colspan="2">; 40-poles max. 80N for PL1-2 / 120N for PL3</td></tr><tr><td>16-pole max. 32N for PL1-2 / 48N for PL3</td><td colspan="2">; 50-poles max. 100N for PL1-2 / 150N for PL3</td></tr><tr><td>20-pole max. 40N for PL1-2 / 60N for PL3</td><td colspan="2">; 60-poles max. 120N for PL1-2 / 180N for PL3</td></tr><tr><td>26-pole max. 52N for PL1-2 / 78N for PL3</td><td colspan="2">; 64-poles max. 128N for PL1-2 / 192N for PL3</td></tr><tr><td rowspan="4">Mating cycles</td><td>S4 surface treatment</td><td colspan="2">Au over PdNi (min. 0,76 µm)</td></tr><tr><td>PL 1 acc. to IEC 60603-13</td><td>500 mating cycles</td><td>10 days gas test</td></tr><tr><td>PL 2 acc. to IEC 60603-13</td><td>250 mating cycles</td><td>4 days gas test</td></tr><tr><td>PL 3 acc. to IEC 60603-13</td><td>50 mating cycles</td><td>No gas test</td></tr><tr><td>UL file</td><td colspan="3">E 102079</td></tr><tr><td>RoHS - compliant</td><td colspan="3">Yes</td></tr><tr><td>Leadfree</td><td colspan="3">Yes</td></tr><tr><td>Hot plugging</td><td colspan="3">No</td></tr></table> Insulator material <table><tr><td>Material</td><td>PBT (thermoplastics, glass fiber reinforcement 30%)</td></tr><tr><td>Color</td><td>black (RAL 7001) or grey (RAL 7032) for solder grey (RAL 7053) for press-in</td></tr><tr><td>UL classification</td><td>UL94-V0</td></tr><tr><td>Material group acc. 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Control and test procedures according to DIN IEC 60512. 1) Temperature rise 2) Derating 3) Derating curve at I max x 0.8(IEC 60512-2) <tr><td>1</td><td>2</td><td>3</td><td>4</td><td>5</td><td>6</td><td>7</td><td>8</td></tr>				Tin plated PCB (HAL) acc. to EN 60352-5	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm	Sn	max. 15 µm	Chemical tin plated PCB	plated hole Ø	0,94 – 1,09 mm	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm	Gold /Nickel plated PCB	Sn	min. 0,8µm	plated hole Ø	1,00 – 1,10 mm	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm	Silver plated PCB	Ni	3 – 7 µm	Au	0,05 – 0,12 µm	plated hole Ø	1,00 – 1,10 mm	Copper plated PCB (OSP)	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm	plated hole Ø	1,00 – 1,10 mm	Material	Polystyrol	Color	Yellow	Standardization	acc. to DIN EN / IEC 61340-5-1 and ANSI / ESD S541-2003		All Dimensions in mm Original Size DIN A3	Scale 1:1	Free size tol.	Ref.					Sub. 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Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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